11-22-00 12-04-2000 Form PTO-1595 ENT OF COMMERCE 1-31-92 rademark Office 101536272 A10 To the Honorable Assistant Commissioner for Pate accarned original documents or copy thereof. NOV 2 2 2000 1. Name of conveying party(ies): Name and address of receiving party(ies)? Yoshihito SEKI and Masahiro KAIZU Name • FUJIKURA LIMITED Internal Address: Additional name(s) of conveying party(ies) attached? 5-1, Kiba 1-chome, Kohtoh-ku, Tokyo, Japan \_ yes Street Address: x no Same as above 3. Nature of Conveyance: City State x Assignment Merger Additional name(s) & address \_\_\_ yes <u>x</u> no Change of Name \_ Security Agreement Other Execution Date: July 21, 2000 Application number(s) or patent number(s) If this document is being filed together with a new application, the execution date of the application is: July 21, 2000 A. Patent Application No.(s) B. Patent No(s). Additional numbers attached? Yes 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: One (1) SUGHRUE, MION, ZINN, MACPEAK & SEAS 2100 Pennsylvania Avenue, N.W. 7. Total Fee (37 CFR 3.41): Suite 800 40.00 x Enclosed. Please charge any underpayment in Washington, D.C. 20037-3202 connection with this Assignment to Deposit Account No. 19-4880. \_\_\_ Authorized to be charged to Deposit Account 8. Deposit Account No. (Attach dupl. copy of this page if paying by Deposit Account) DO NOT WRITE IN THIS SPACE 9. Statement and Signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. MAGILLAT F August 9, 2000 Waddell A. Biggart Reg. No./ TOTAL NUMBER OF PAGES INCLUDING COVER SHEET, ATTACHMENTS AND DOCUMENT: OMB No. 0651-0011 (exp. 4/94) 09/15/2000 NTHAI1 00000390 WADDELL BIGGART Do not detach this portion

Assistant Commissioner for Patents
Box Assignments
Washington, D.C. 20231

01 FQ 544il documents to be recorded with required cover sheet information to:

PATENT REEL: 011291 FRAME: 0834

## ASSIGNMENT

In consideration of value received, I, having a residence and post office address as stated below next to my name, the sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of an invention described in an application for United States patent entitled:

CHIP ASSEMBLY MODULE OF BUMP CONNECTION TYPE USING A MULTI-LAYER PRINTED CIRCUIT SUBSTRATE

said application having been filed on and assigned Serial No.; sell and assign to Fujikura Ltd. a corporation of Japan, having a business address at 5-1. Kiba 1-chome. Kohtoheku, Tokyo, Japan

its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention as disclosed, shown and described in said application for United States patent: (check one)

 $\times$  executed concurrently herewith:

executed separately herefrom;

and in and to all applications for patent and patents for said invention, in all countries of the world, including all divisions, reissues, continuations, substitutions and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property, including rights of priority, resulting from the filing of any of said applications; and I authorize and request any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, re ssue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid saic Assignee to obtain and enferce proper patent protection for said invension in all countries.

I hereby grant the following law firm the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the Rules of the U.S. Patent and Trademark Office for recordation of this document.

Sughrue, Mion, Zinn, Macpeak & Seas, 2100 Pennsylvania Avenue, N.W. Washington, D.C. 20037-3202

PATENT REEL: 011291 FRAME: 0835

## ASSIGNMENT

Inventor: (Signature)	Date	Residence and post office address
Yoshihito Seki	July 21, 2000	1-22-20, Oosakidai, Sakura-shi. Chiba-ken, Japan
Masahiro Kaizu	July 21, 2000	2-25-9, Tamatsukuri, Narita-shi, Chiba-ken, Japan

RECORDING OFFICER:

After recording please return to: SUGHRUE, MION, ZINN. MACPEAK & SEAS,

2100 Pennsylvania Avenue, N.W., Washington, D.C. 20037-3202

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